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6/18/02

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of: Tomoo IJIMA et al.

Serial Number: 09/466,895

Filed: December 20, 1999

Group Art Unit: 3729

For: WIRING SUBSTRATE FOR MOUNTING
SEMICONDUCTOR ELEMENTS AND
FABRICATING METHOD THEREOF

Examiner: S. SMITH

AMENDMENT UNDER 37 CFR §1.111

Commissioner for Patents
Washington, D.C. 20231
Sir:

January 14, 2002

In response to the Office Action dated September 14, 2001, extended to January 14, 2002
by a one-month Petition for Extension of Time, please amend the above-identified application as
follows:

IN THE TITLE:

Amend the title to read as follows:

~~/~~ METHOD FOR FABRICATING A WIRING SUBSTRATE

IN THE ABSTRACT:

~~/~~ Delete the current Abstract and replace therewith the attached substitute Abstract.

IN THE CLAIMS:

~~/~~ Please cancel claims 1 and 3-14 without prejudice or disclaimer.

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